

Data sheet acquired from Harris Semiconductor SCHS205I

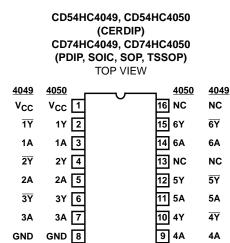
CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

February 1998 - Revised February 2005

Features

- Typical Propagation Delay: 6ns at $V_{CC} = 5V$, $C_L = 15pF$, $T_A = 25^{\circ}C$
- High-to-Low Voltage Level Converter for up to V_I = 16V
- Fanout (Over Temperature Range)
 - Standard Outputs..... 10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range ... –55°C to 125°C
- · Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: N_{IL} = 30%, N_{IH} = 30% of V_{CC} at V_{CC} = 5V

Pinout



High-Speed CMOS Logic Hex Buffers, Inverting and Non-Inverting

Description

The 'HC4049 and 'HC4050 are fabricated with high-speed silicon gate technology. They have a modified input protection structure that enables these parts to be usedas logic level translators which convert high-level logic to a low-level logic while operating off the low-level logic supply. For example, 15-V input pulse levels can be down-converted to 0-V to 5-V logic levels. The modified input protection structure protects the input from negative electrostatic discharge. These parts also can be used as simple buffers or inverters without level translation. The 'HC4049 and 'HC4050 are enhanced versions of equivalent CMOS types.

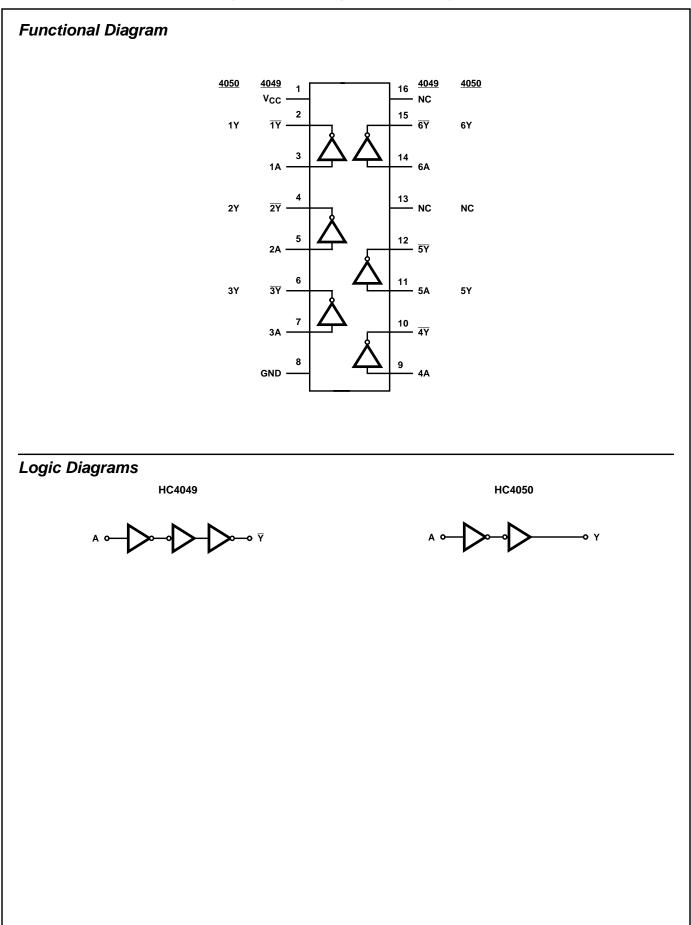
Ordering Information

PART NUMBER	TEMP. RANGE (^o C)	PACKAGE
CD54HC4049F3A	-55 to 125	16 Ld CERDIP
CD54HC4050F3A	-55 to 125	16 Ld CERDIP
CD74HC4049E	-55 to 125	16 Ld PDIP
CD74HC4049M	-55 to 125	16 Ld SOIC
CD74HCT4050MT	-55 to 125	16 Ld SOIC
CD74HC4049M96	-55 to 125	16 Ld SOIC
CD74HC4049NSR	-55 to 125	16 Ld SOP
CD74HC4049PW	-55 to 125	16 Ld TSSOP
CD74HC4049PWR	-55 to 125	16 Ld TSSOP
CD74HC4049PWT	-55 to 125	16 Ld TSSOP
CD74HC4050E	-55 to 125	16 Ld PDIP
CD74HC4050M	-55 to 125	16 Ld SOIC
CD74HC4050MT	-55 to 125	16 Ld SOIC
CD74HC4050M96	-55 to 125	16 Ld SOIC
CD74HC4050NSR	-55 to 125	16 Ld SOP
CD74HC4050PW	-55 to 125	16 Ld TSSOP
CD74HC4050PWR	-55 to 125	16 Ld TSSOP
CD74HC4050PWT	-55 to 125	16 Ld TSSOP

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper IC Handling Procedures.

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Absolute Maximum Ratings

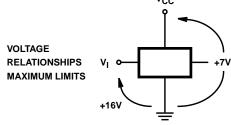
DC Supply Voltage, V _{CC} 0.5V to 7V
Input Voltage Range–0.5V to 16V
DC Input Diode Current, IIK
For V _I < –0.5V–20mA
DC Output Diode Current, IOK
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V\pm 20$ mA
DC Output Source or Sink Current per Output Pin, IO
For $V_0 > -0.5V$ or $V_0 < V_{CC} + 0.5V$
DC V _{CC} or Ground Current, I _{CC or} I _{GND} ±50mA

Operating Conditions

Temperature Range (T_A)
Supply Voltage Range, V _{CC}
HC Types
HCT Types4.5V to 5.5V
DC Input Voltage, V ₁ 0V to 15V
DC Output Voltage, V _O 0V to V _{CC}
Input Rise and Fall Time
2V
4.5V 500ns (Max)
6V

Thermal Information

Package Thermal Impedance, θ_{JA} (see Note 1):
E (PDIP) Package
M (SOIC) Package73 ⁰ C/W
NS (SOP) Package 64 ^o C/W
PW (TSSOP) Package 108 ^o C/W
Maximum Junction Temperature (Hermetic Package or Die) 175 ^o C
Maximum Junction Temperature (Plastic Package)
Maximum Storage Temperature Range
Maximum Lead Temperature (Soldering 10s)
(SOIC - Lead Tips Only)
Vcc



CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

		TEST CONDITIONS		Vcc	25 ⁰ C			–40°C TO 85°C		–55°C TO 125°C		
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES												
High Level Input	VIH	-	-	2	1.5	-	-	1.5	-	1.5	-	V
Voltage				4.5	3.15	-	-	3.15	-	3.15	-	V
				6	4.2	-	-	4.2	-	4.2	-	V
Low Level Input	VIL	-	-	2	-	-	0.5	-	0.5	-	0.5	V
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V
				6	-	-	1.8	-	1.8	-	1.8	V
High Level Output Voltage CMOS Loads	VOH	V _{IH} or V _{IL}	-0.02	2	1.9	-	-	1.9	-	1.9	-	V
			-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
			-0.02	6	5.9	-	-	5.9	-	5.9	-	V
High Level Output			-4	4.5	3.98	-	-	3.84	-	3.7	-	V
Voltage TTL Loads			-5.2	6	5.48	-	-	5.34	-	5.2	-	V
Low Level Output	V _{OL}	$V_{\text{IH}} \text{ or } V_{\text{IL}}$	0.02	2	-	-	0.1	-	0.1	-	0.1	V
Voltage CMOS Loads			0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
			0.02	6	-	-	0.1	-	0.1	-	0.1	V
Low Level Output			4	4.5	-	-	0.26	-	0.33	-	0.4	V
Voltage TTL Loads			5.2	6	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	lı	V _{CC} or GND	-	6	-	-	±0.1	-	±1	-	±1	μΑ
		15	-	6	-	-	±0.5	-	±5	-	±5	

CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

		-	EST	v _{cc}		25 ⁰ C			–40°C TO 85°C		–55°C TO 125 [°] C		
PARAMETER SYN	SYMBOL	. V _I (V)	I _O (mA)	(V)	MIN	I T	YP I	MAX	MIN	MAX	MIN	MAX	UNITS
Quiescent Device Current	Icc	V _{CC} or GND	0	6 -		- 2		2	- 20		- 40		μA
Switching Speci	fications	Input t _r , t _f =	6ns	_						_		-	
			TEST				25 ⁰ C			0°С ТО 85 ⁰ С		°C TO 5°C	
PARAMETE	R	SYMBOL	CONDITION	NS V _{CC} (V)		MIN	TYP	MAX	(MIN	N MAX	MIN	MAX	UNITS
HC TYPES													
Propagation Delay,		t _{PLH} , t _{PHL}	$C_L = 50 pF$	2		-	-	85	-	105	-	130	ns
nA to nY HC4049 nA to nY HC4050				4.5		-	-	17	-	21	-	26	ns
				6		-	-	14	-	18	-	22	ns
			C _L = 15pF	5		-	6	-	-	-	-	-	ns
Transition Times (Fig	ure 1)	t _{TLH} , t _{THL}	$C_L = 50 pF$	2		-	-	75	-	95	-	110	ns
				4.5	;	-	-	15	-	19	-	22	ns
				6		-	-	13	-	16	-	19	ns
Input Capacitance		CI	-	-		-	-	10	-	10	-	10	pF

5

35

pF

NOTES:

(Notes 2, 3)

2. $C_{\mbox{PD}}$ is used to determine the dynamic power consumption, per gate.

CPD

3. $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where f_i = Input Frequency, C_L = Output Load Capacitance, V_{CC} = Supply Voltage.

Test Circuit and Waveform

Power Dissipation Capacitance

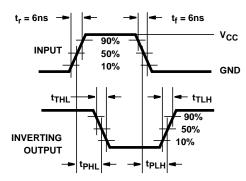


FIGURE 1. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8681901EA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8681901EA CD54HC4049F3A	Samples
5962-8682001EA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8682001EA CD54HC4050F3A	Samples
CD54HC4049F3A	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8681901EA CD54HC4049F3A	Samples
CD54HC4050F3A	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type -55 to 125		5962-8682001EA CD54HC4050F3A	Samples
CD74HC4049E	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74HC4049E	Samples
CD74HC4049EE4	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74HC4049E	Samples
CD74HC4049M	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4049M	
CD74HC4049M96	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4049M	Samples
CD74HC4049M96G4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4049M	Samples
CD74HC4049MT	LIFEBUY	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4049M	
CD74HC4049NS	LIFEBUY	SO	NS	16	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		HC4049M	
CD74HC4049NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4049M	Samples
CD74HC4049PW	LIFEBUY	TSSOP	PW	16	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4049	
CD74HC4049PWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4049	Samples
CD74HC4050E	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74HC4050E	Samples
CD74HC4050M	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4050M	
CD74HC4050M96	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4050M	Samples
CD74HC4050ME4	LIFEBUY	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4050M	
CD74HC4050MT	LIFEBUY	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4050M	
CD74HC4050NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HC4050M	Samples
CD74HC4050PW	LIFEBUY	TSSOP	PW	16	90	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4050	
CD74HC4050PWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4050	Samples



Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CD74HC4050PWRG4	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4050	Samples
CD74HC4050PWT	LIFEBUY	TSSOP	PW	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	HJ4050	

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures. "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF CD54HC4049, CD54HC4050, CD74HC4049, CD74HC4050 :



18-Nov-2023

• Catalog : CD74HC4049, CD74HC4050

• Military : CD54HC4049, CD54HC4050

NOTE: Qualified Version Definitions:

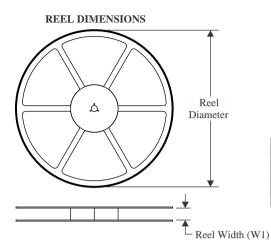
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

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Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74HC4049M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4049NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD74HC4049PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4050M96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD74HC4050NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
CD74HC4050PWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
CD74HC4050PWT	TSSOP	PW	16	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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PACKAGE MATERIALS INFORMATION

25-Aug-2023



Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD74HC4049M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4049NSR	SO	NS	16	2000	356.0	356.0	35.0
CD74HC4049PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4050M96	SOIC	D	16	2500	340.5	336.1	32.0
CD74HC4050NSR	SO	NS	16	2000	356.0	356.0	35.0
CD74HC4050PWR	TSSOP	PW	16	2000	356.0	356.0	35.0
CD74HC4050PWT	TSSOP	PW	16	250	356.0	356.0	35.0

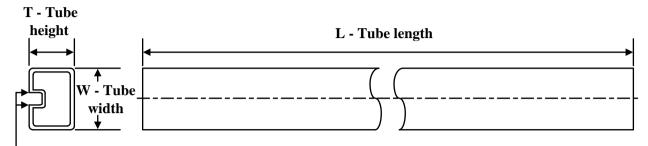
Pack Materials-Page 2

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal	

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD74HC4049E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4049E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4049EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4049EE4	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4049M	D	SOIC	16	40	507	8	3940	4.32
CD74HC4049NS	NS	SOP	16	50	530	10.5	4000	4.1
CD74HC4049PW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD74HC4050E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4050E	N	PDIP	16	25	506	13.97	11230	4.32
CD74HC4050M	D	SOIC	16	40	507	8	3940	4.32
CD74HC4050ME4	D	SOIC	16	40	507	8	3940	4.32
CD74HC4050PW	PW	TSSOP	16	90	530	10.2	3600	3.5

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